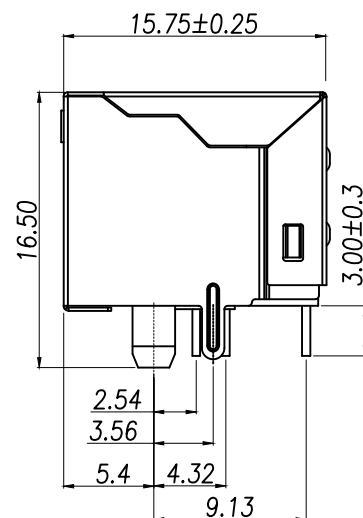
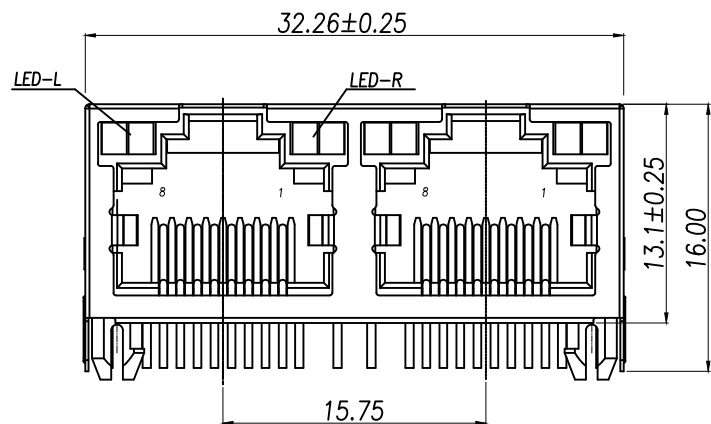




NOTES

MATERIAL

1.HOUSING MATERIAL

2. CONTACT MATERIAL

3. PLATING

4. SHIELD

: THERMO PLASTICS UL94V-0.

: PHOSPHOR BRONZE $\phi 0.46\text{mm}$.

: GOLD FLASH PLATING OVER NICKEL.

: 0.20mm THICKNESS COPPER ALLOY
WITH NICKEL PLATED.

ELECTRICAL

1.VOLTAGE RATING

: 125 VAC RMS.

2.CURRENT RATING

: 1.5 AMP.

3. CONTACT RESISTANCE

: 40 MILLIOHMS MAX.

4.INSULATION RESISTANCE

: 500 MEGOHMS MIN @ 100V DC .

5. DIELECTRIC DIELECTRIC

. 500 MEGOHMS MIN @ 100V D

RESISTANCE

: 500V DC RMS 50Hz. 1MIN.

MECHANICAL

MECHANICAL

1.DURRABILITY

: 750 CYCLES MIN.

2. MATING/UNMATING FORC: 2.24 KG.F MAX.

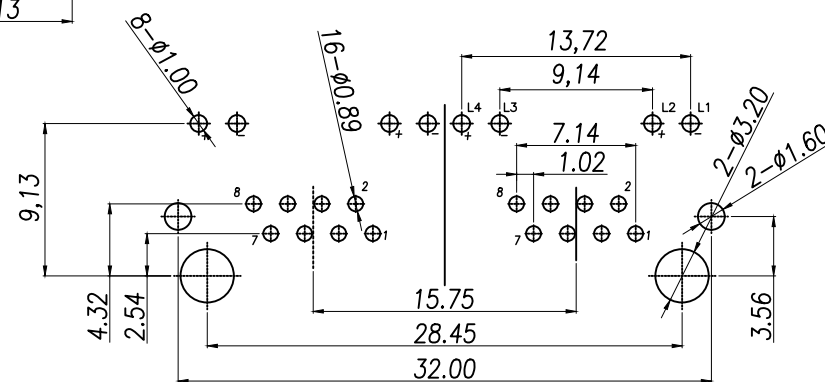
ENVIRONMENTAL:

1. OPERATION

$$: -40r \sim +85r.$$

2.STORAGE

: -40r~+85r.



PCBLAYOUT

TOL: ± 0.05

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd					
TOLERANCE UNLESS OTHERWISE SPECIFIED							
.X±0.35	.X*±3	APR. Alex	TITLE: 56S 1x2贴片电阻DIP GF PBT				
.XX±0.25	.X*±2	CHK. Jack	DWG NO. XY-RJ056-8P8C-1X2				
.XXX±0.15	.XX*±1*	DRA. Can	PROJ. 		CUSTOMER DRAWING		
			SIZE A4	SCALE 1:1	SHEET 1/1	REV. A	